## 2SC3130

### Silicon NPN epitaxial planar type

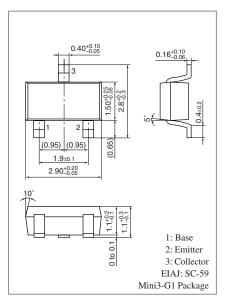
#### For high-frequency amplification/oscillation/mixing

#### ■ Features

- High transition frequency f<sub>T</sub>
- ullet Small collector output capacitance (Common base, input open circuited)  $C_{ob}$  and reverse transfer capacitance (Common emitter)  $C_{rb}$
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	15	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	10	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	3	V	
Collector current	$I_C$	50	mA	
Collector power dissipation	P <sub>C</sub>	150	mW	
Junction temperature	$T_{j}$	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



Marking Symbol: 1S

#### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 2 \text{ mA}, I_B = 0$	10			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \ \mu A, I_C = 0$	3			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 10 \text{ V}, I_E = 0$			1	μΑ
Forward current transfer ratio *1	h <sub>FE</sub>	$V_{CE} = 4 \text{ V}, I_C = 5 \text{ mA}$	75		220	_
h <sub>FE</sub> ratio *2	$\Delta h_{FE}$	$h_{FE2}$ : $V_{CE} = 4 \text{ V}$ , $I_{C} = 100 \mu\text{A}$	0.75		1.60	_
		$h_{\text{FEI}}$ : $V_{\text{CE}} = 4 \text{ V}$ , $I_{\text{C}} = 5 \text{ mA}$				
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 20 \text{ mA}, I_B = 4 \text{ mA}$			0.5	V
Transition frequency	$f_T$	$V_{CB} = 4 \text{ V}, I_E = -5 \text{ mA}, f = 200 \text{ MHz}$	1.4	1.9	2.5	GHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 4 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		1.4		pF
(Common base, input open circuited)						
Reverse transfer capacitance	C <sub>rb</sub>	$V_{CB} = 4 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		0.45		pF
(Common emitter)						
Collector-base parameter	r <sub>bb</sub> ' • C <sub>C</sub>	$V_{CB} = 4 \text{ V}, I_E = -5 \text{ mA}, f = 31.9 \text{ MHz}$		11		ps

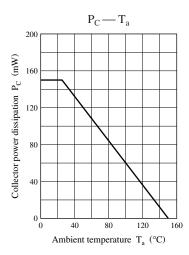
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

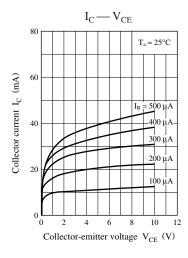
#### 2. \*1: Rank classification

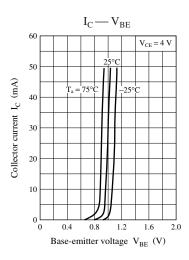
Rank	Р	Q
$h_{\mathrm{FE}}$	75 to 130	110 to 220

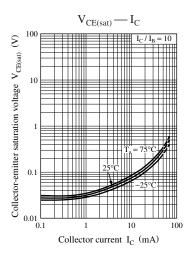
\*2:  $\Delta h_{FE} = h_{FE2} / h_{FE1}$ 

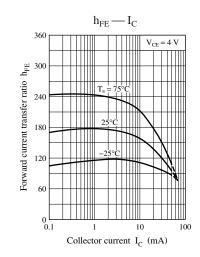
### **Panasonic**

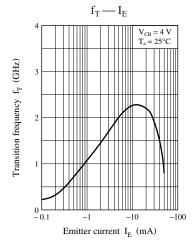


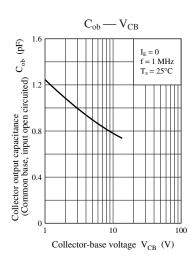












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